

3.3 V LVDS, 2-Bit, High-Speed, Differential Driver

FIN1027A

General Description

This dual driver is designed for high-speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver translates LVTTL signal levels to LVDS levels with a typical differential output swing of 350 mV, which provides low EMI at ultra-low power dissipation, even at high frequencies. This device is ideal for high-speed transfer of clock or data.

The FIN1027A can be paired with its companion receiver, the FIN1028, or with any other LVDS receiver

Features

- Greater than 600 Mbs Data Rate
- 3 V Power Supply Operation
- 5 ns Maximum Differential Pulse Skew
- 1.5 ns Maximum Propagation Delay
- Low Power Dissipation
- Power-Off Protection
- Meets or Exceeds the TIA/EIA-644 LVDS Standard
- Flow-through Pinout Simplifies PCB Layout
- This Device is Pb-Free, Halide Free and is RoHS Compliant

PIN CONFIGURATION

Name	Pin#	Description	
V _{CC}	1	Power Supply	
D _{IN1}	2	LVTTL Data Input	
D _{IN2}	3	LVTTL Data Input	
GND	4	Ground	
D _{OUT2}	5	Inverting Driver Output	
D _{OUT2+}	6	Non-Inverting Driver Output	
D _{OUT1+}	8	Non-Inverting Driver Output	
D _{OUT1}	7	Inverting Driver Output	

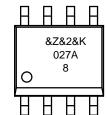
FUNCTIONAL TABLE

Input	Outputs			
D _{IN}	D _{OUT+}	D _{OUT-}		
LOW	LOW	HIGH		
HIGH	HIGH	LOW		
OPEN	LOW	HIGH		



SOIC8 CASE 751EB

MARKING DIAGRAM

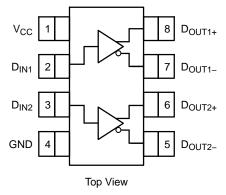


&Z = Assembly Plant Code&2 = 2-Digit Date Code

&K = 2-Digits Lot Run Traceability Code

027A8 = Specific Device Code

PIN CONFIGURATION



ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Unit
V_{CC}	Supply Voltage	-0.5	4.6	V
D _{IN}	DC Input Voltage	-0.5	6.0	V
D _{OUT}	DC Output Voltage	-0.5	4.7	V
I _{OSD}	Driver Short–Circuit Current	Continuous		mA
T _{STG}	Storage Temperature Range	-65	+150	°C
T_J	Maximum Junction Temperature	-	+150	°C
TL	Lead Temperature, Soldering, 10 Seconds	-	+260	°C
ESD	Human Body Model, JESD22-A114	-	≥6500	V
	Machine Model, JESD22-A115	_	≥400	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	Supply Voltage	3.0	3.6	V
V _{IN}	Input Voltage	0	V _{CC}	V
T _A	Operating Temperature	-40	+85	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS (All typical values are at $T_A = 25$ °C and with $V_{CC} = 3.3$ V. Over–supply voltage and operating temperature ranges, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OD}	Output Differential Voltage	R_L = 100 Ω, See Figure 1	250	350	450	mV
ΔV_{OD}	VOD Magnitude Change from Differential LOW-to-HIGH		-	_	25	mV
Vos	Offset Voltage		1.125	1.250	1.375	V
ΔV_{OS}	Offset Magnitude Change from Differential LOW-to-HIGH		-	_	25	mV
I _{OFF}	Power-Off Output Current	V _{CC} = 0 V, V _{OUT} = 0 V or 3.6 V	-	-	±20	μΑ
Ios	Short-Circuit Output Current	V _{OUT} = 0 V	_	-	-8	mA
		V _{OD} = 0 V	-	-	±8	
V _{IH}	Input HIGH Voltage		2.0	-	V _{CC}	V
V _{IL}	Input LOW Voltage		GND	-	0.8	V
I _{IN}	Input Current	V _{IN} = 0 V or V _{CC}	-	-	±20	μА
I _{I(OFF)}	Power-Off Input Current	V _{CC} = 0 V, V _{IN} = 0 V or 3.6 V	-	-	±20	μΑ
V _{IK}	Input Clamp Voltage	I _{IK} = -18 mA	-1.5	-	-	V
Icc	Power Supply Current	No Load, V _{IN} = 0 V or V _{CC}	_	-	12.5	mA
		$R_L = 100 \Omega$, $V_{IN} = 0 V$ or V_{CC}	-	-	17.0	mA
CIN	Input Capacitance		-	4	-	pF
Соит	Output Capacitance		-	6	-	pF

AC ELECTRICAL CHARACTERISTICS (All typical values are at $T_A = 25$ °C and with $V_{CC} = 3.3$ V. Over–supply voltage and operating temperature ranges, unless otherwise specified.)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
t _{PLHD}	Differential Propagation Delay, LOW-to-HIGH	$R_L = 100 \Omega$, $CL = 10 pF$,	0.5	_	1.5	ns
t _{PHLD}	Differential Propagation Delay, HIGH-to-LOW	see Figure 2 and Figure 3	0.5	-	1.5	ns
t _{TLHD}	Differential Output Rise Time (20% to 80%)		0.4	_	1.0	ns
t _{THLD}	Differential Output Fall Time (80% to 20%)		0.4	_	1.0	ns
t _{SK(P)}	Pulse Skew t _{PLH} - t _{PHL}		-	_	0.5	ns
t _{SK(LH)} , t _{SK(HL)}	Channel-to-Channel Skew (Note 1)		_	_	0.3	ns
t _{SK(PP)}	Part-to-Part Skew (Note 2)		_	_	1.0	ns

t_{SK(LH)}, t_{SK(HL)} is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.

TEST DIAGRAMS

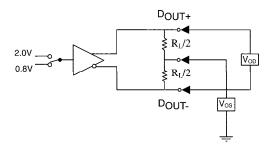


Figure 1. Differential Driver DC Test Circuit

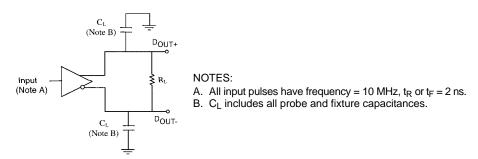


Figure 2. Differential Driver Propagation Delay and Transition Time Test Circuit

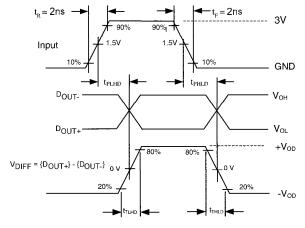


Figure 3. AC Waveforms

t_{SK(PP)} is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

TYPICAL PERFORMANCE CHARACTERISTICS

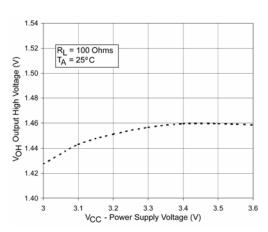


Figure 4. Output High Voltage vs. Power Supply Voltage

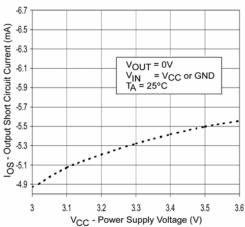


Figure 6. Output Short Circuit Current vs. Power Supply Voltage

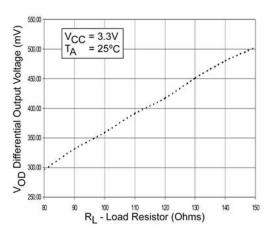


Figure 8. Differential Output Voltage vs. Load Resistor

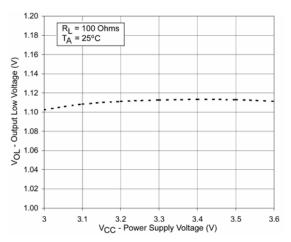


Figure 5. Output Low Voltage vs. Power Supply Voltage

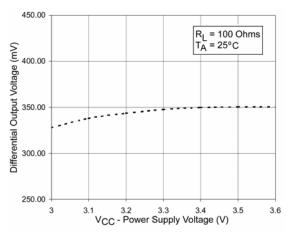


Figure 7. Differential Output Voltage vs. Power Supply Voltage

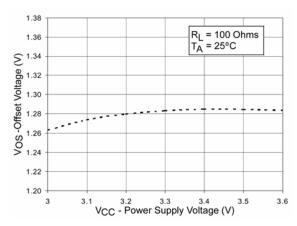


Figure 9. Offset Voltage vs. Power Supply Voltage

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

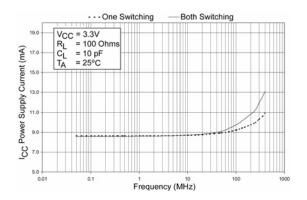


Figure 10. Power Supply Current vs. Frequency

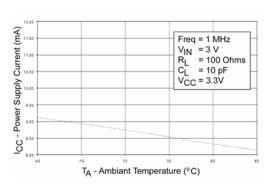


Figure 12. Power Supply Current vs. Ambient Temperature

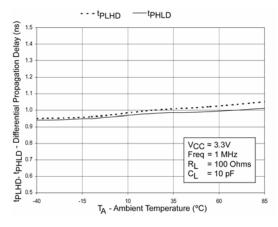


Figure 14. Differential Propagation Delay vs.

Ambient Temperature

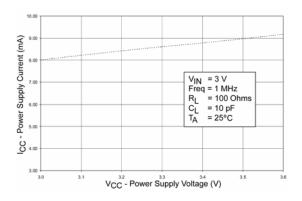


Figure 11. Power Supply Current vs. Power Supply Voltage

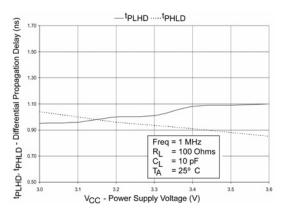


Figure 13. Differential Propagation Delay vs. Power Supply

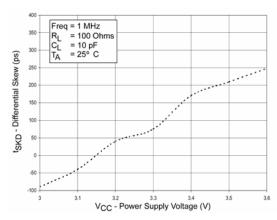


Figure 15. Differential Skew (t_{PLH} – t_{PHL}) vs. Power Supply

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

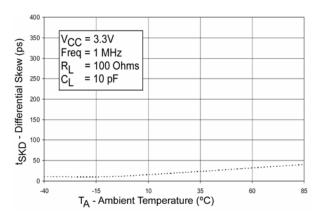


Figure 16. Differential Pulse Skew (t_{PLH} - t_{PHL})

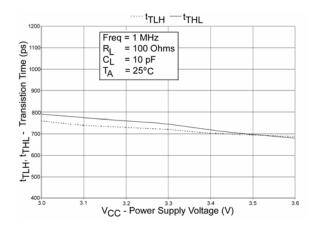


Figure 17. Transition Time vs. Power Supply Voltage

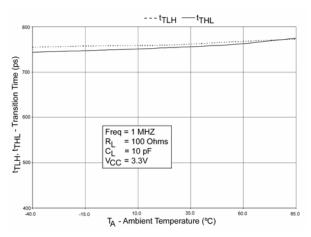
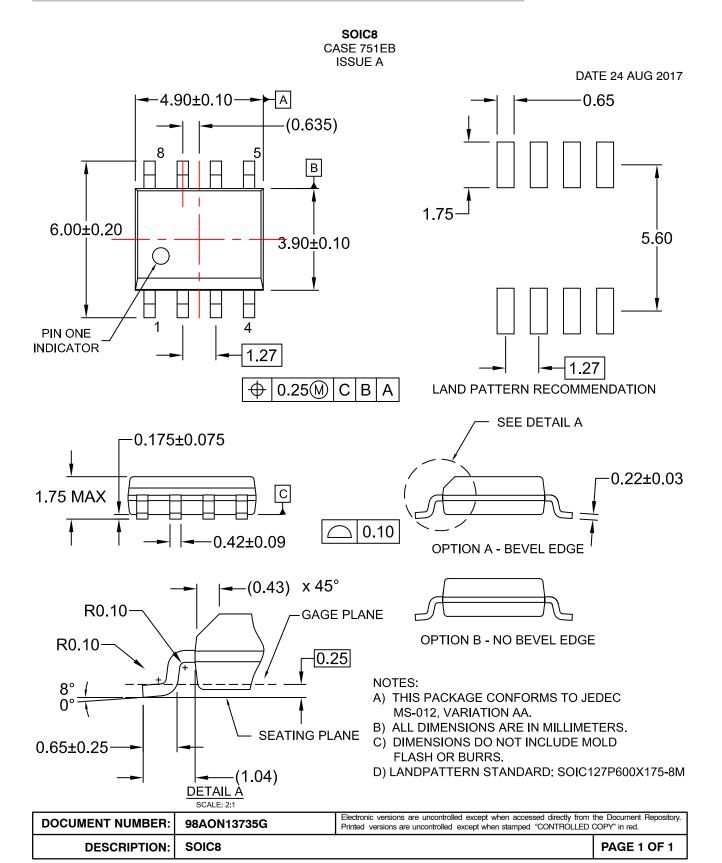


Figure 18. Transition Time vs. Ambient Temperature

ORDERING INFORMATION

Part Number	Operating Range Temperature	Package	Shipping [†]
FIN1027AMX	−40 to +85°C	8-Lead Small Outline Package (SOIC), JEDEC MS-012, 0.150 inch Narrow (Pb-Free, Halide Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales